

IN THE SPECIFICATION:

Please amend the Specification as follows:

Please change the paragraph at page 2, lines 5-13 to read as follows:

The present invention provides a component mounting circuit board comprising a circuit pattern including a plurality of electrically conductive plates, an inner electrical component electrically connected to the circuit pattern, and a resin molded section made of a resin by way of molding so as to cover the circuit pattern and the inner electrical component, the resin molded section having an opening allowing an outer electrical component located outside the resin molded section to be connected to the circuit pattern therethrough[[]], and a metal member embedded in the resin molded section so as to be located to correspond to a portion of the inner electrical component and electrically insulated from the circuit pattern, the metal member being provided with an exposed portion exposed outside the resin molded section.

Please change the 3 paragraphs from page 2, line 27 through page 3, line 25 to read as follows:

The invention also provides a component mounting circuit board comprising a circuit pattern including a plurality of electrically conductive plates, an inner electrical component electrically connected to the circuit pattern, a resin molded section made of a resin by way of molding so as to cover the circuit pattern and the inner electrical component, the resin molded section having an opening allowing an outer electrical component located outside the resin molded section to be connected to the circuit pattern therethrough, and a metal member embedded in the resin molded section so as to be located at a portion corresponding to the inner electrical component, the metal member being discrete from the circuit pattern.

~~The resin molded section is preferably made of an epoxy resin. Further, the circuit pattern preferably includes a portion corresponding to the inner electrical component and provided with a thicker portion thicker than a remaining portion. Additionally, the circuit pattern preferably includes a portion corresponding to the inner electrical component and provided with an exposed portion exposed outside the resin molded section.~~

~~The component mounting circuit board preferably further comprises a metal member embedded in the resin molded section so as to be located to correspond to a portion of the inner~~

~~electrical component and electrically insulated from the circuit pattern, the metal member being provided with an exposed portion exposed outside the resin molded section. Further, the component mounting circuit board preferably further comprises a metal member embedded in the resin molded section so as to be located at a portion corresponding to the inner electrical component, the metal member being discrete from the circuit pattern.~~

~~The component mounting circuit board preferably further comprises a support provided on the resin molded section to support the outer electrical component. Further, the component mounting circuit board further comprises a terminal provided on the circuit pattern so as to project outside the resin molded section. The inner electrical component is preferably connected to the circuit pattern by wire bonding. The outer electrical component is soldered to a portion of the circuit pattern corresponding to the opening.~~